



Micron Technology, Inc.
Quality & Reliability Assurance Dept
Mail Stop 502
8000 S. Federal Way
P.O. Box 6
Boise, Idaho 83707-0006

RE: RoHS Certification

Micron Technology, Inc. certifies that our Pb-free die/wafer, component and module level products meet the requirements of the current DIRECTIVE 2002/95/EC, a.k.a. Restriction of Hazardous Substances (RoHS) Directive without exemptions. Micron's Pb-free products mentioned above contain less than the following amounts of the six RoHS banned substances:

- Less than 0.1% Lead – Pb
- Less than 0.1% Mercury – Hg
- Less than 0.01% Cadmium – Cd
- Less than 0.1% Hexavalent Chromium – Cr (VI)
- Less than 0.1% Polybrominated Biphenyls - PBB
- Less than 0.1% Polybrominated Diphenyl Ethers – PBDE
- Less than 0.1% Decabromodiphenyl Ether - DecaBDE

Please note that our module level products do contain electronic ceramic passive parts that may use lead-oxides which are exempt from Directive 2002/95/EC (see Article 4, Section 2, Item 5, and 7 of the Annex thereto).

The only RoHS banned substance present in non-RoHS compliant die/wafer, component and module level products manufactured by Micron Technology, Inc., is Pb (present in the interconnect material used for packaged devices).

Further questions should be addressed to your local Micron sales representative.

Signature: _____
(Authorized representative of Micron Technology, Inc.)

Date: June 18, 2008

Name: Julie Grapatin

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Title: QRA Customer Support Specialist

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